



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*[Handwritten signature]*

Application of: NAKAMURA et al.

Application No.: 10/648,762

Filed: August 26, 2003

Publication No.: 2004/0121260A1

BASE MATERIAL FOR LITHOGRAPHY

RECEIVED

JUL 27 2004

TC 1700

SUBMISSION UNDER 37 CFR 1.99

Commissioner for Patents  
Washington, D.C. 20231

Sir:

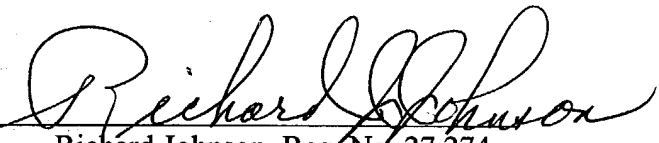
Please enter this submission in the file of the above application. The following patents are being submitted for consideration by the Office:

1. U.S. Patent No. 5,234,990 to Flaim et al., issued on August 10, 1993, from U.S. Patent Application No. 835,715, filed February 12, 1992;
2. U.S. Patent No. 5,919,599 to Meador et al., issued on July 6, 1999, from U.S. Patent Application No. 08/940,169, filed September 30, 1997;
3. U.S. Patent No. 5,851,730 to Thackeray et al., issued on December 22, 1998, from U.S. Patent Application No. 978,827, filed November 26, 1997;
4. U.S. Patent No. 5,886,102 to Senta et al., issued on March 23, 1999, from U.S. Patent Application No. 665,019, filed June 11, 1996; and
5. U.S. Patent No. 5,756,255 to Sato et al., issued on May 26, 1998, from U.S. Patent Application No. 747,567, filed November 12, 1996.

A check for the sum of \$180.00 is enclosed to cover the submission fee under 37 CFR 1.17(p).

The undersigned certifies that a copy of this submission has been sent by postage prepaid first class mail to John W. Ryan, Dechert LLP, Princeton Pike Corporation Center, P.O. Box 5218, Princeton, NJ 08543-5218.

Respectfully submitted,

By   
Richard Johnson, Reg. No. 27,274  
5612 18<sup>th</sup> Street North  
Arlington, VA 22205